

**POSITIVE PHOTSENSITIVE RESIN COMPOSITION, AND  
SEMICONDUCTOR DEVICE AND DISPLAY THEREWITH**

**ABSTRACT**

Disclosed is a positive photosensitive resin composition containing (A) an alkali-soluble resin, (B) a diazoquinone compound, (d1) an activated silicon compound and (d2) an aluminum complex. Also disclosed is a positive photosensitive resin composition containing (A) an alkali-soluble resin, (B) a diazoquinone compound, (C) a compound having two or more oxetanyl groups in one molecule and (D) a catalyst for accelerating the ring-opening reaction of the oxetanyl groups of the compound (C).

**FIGURE 1**